Partner Presentation

The Virtualized Infrastructure for Industrial Automation Based on Intel 12th Core Processor and Ubuntu

Jarry Chang, DFI



What's DFI

Industrial Computer Solutions

 From Modules and Boards to Integrated Systems and Embedded Solutions.





TGU171 (11th Generation Intel® Core™ Processors)



ADS310 (12th Generation Intel® Core™ Processors)

From Small To Large

Industrial Motherboards



System-On-Modules







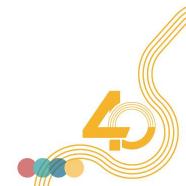


Industrial Computers



Industrial Panel PCs & Displays



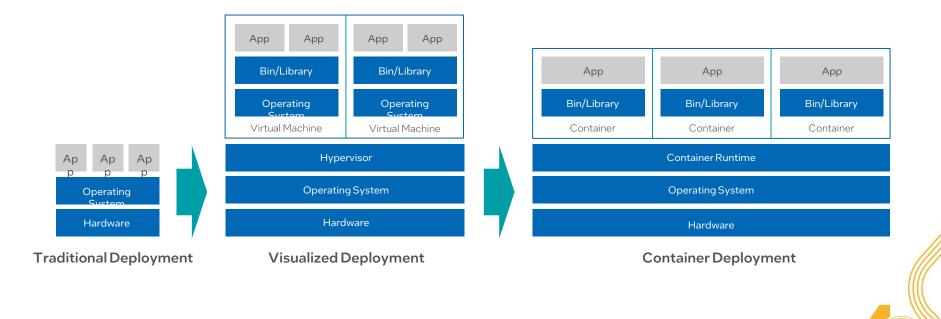


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WORKLOAD CONSOLIDATION IN INDUSTRIAL IOT

Using Virtualization Technologies to Transform Operations for a More Efficient Industry

Differences between virtualization and containerization

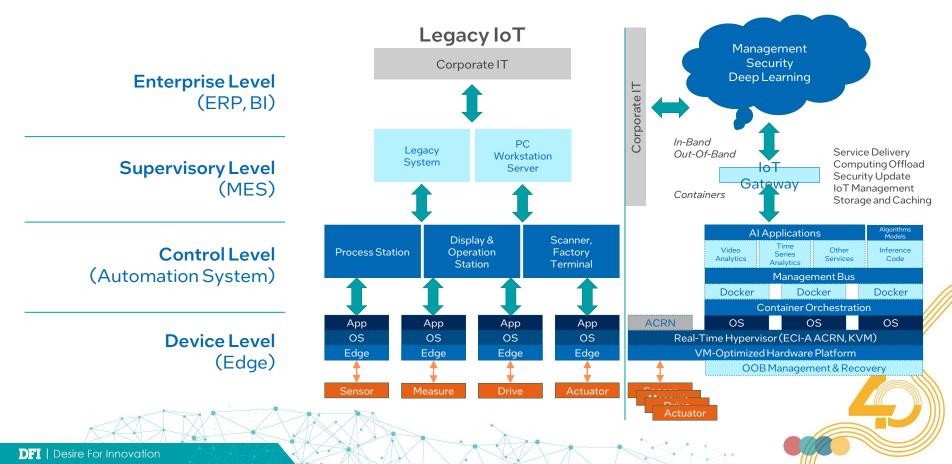


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Workload Consolidation at the Edge



3C: Cloud, Container, Consolidation de Alot



ENABLING TECHNOLOGIES – GFX VIRTUALIZATION

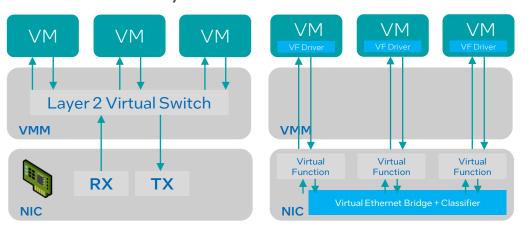
Introducing the main current virtualization technologies and emphasize the importance of Graphics SR-IOV.

SR-IOV (Single Root I/O Virtualization): NIC as Example

Isolation of PCIe resources for manageability and performance

SR-IOV

Previously



Virtual Function (VF) Driver

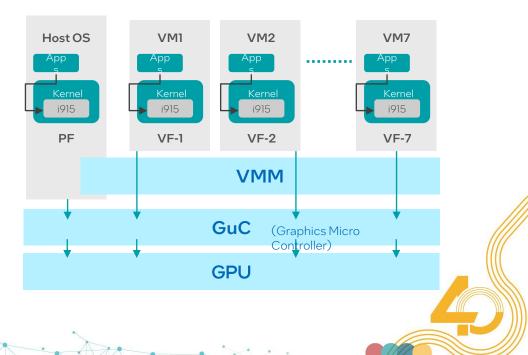
Virtual Function (VF) Physical Function (PF)

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Graphics SR-IOV: Improving Graphic Virtualization

High-quality and high-performance with minimal software overhead

- The graphics virtualization infrastructure is exposed to system software by the Single Root I/O virtualization standard (SR-IOV), of the PCIe standard.
- PCIe interface allow multiple software stacks(VM) to each get their own "graphics device."
- Each VM can access fully accelerated graphics capabilities.
- Able to support up to 7 virtual functions.



ADL-S is The First Platform Supporting iGFX SR-IOV



SR-IOV VF Driver not be installed 28 FPS

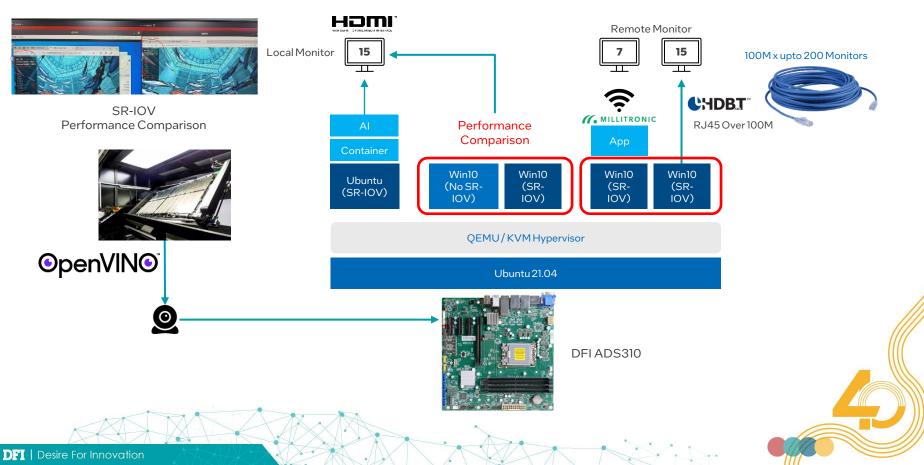
SR-IOV VF Driver installed 60 FPS

Intel[®] Xe Graphics architecture, 4 Independent Displays, Up to 8K Display

THE DETAILS AND PERFORMANCE OF SR-IOV POC

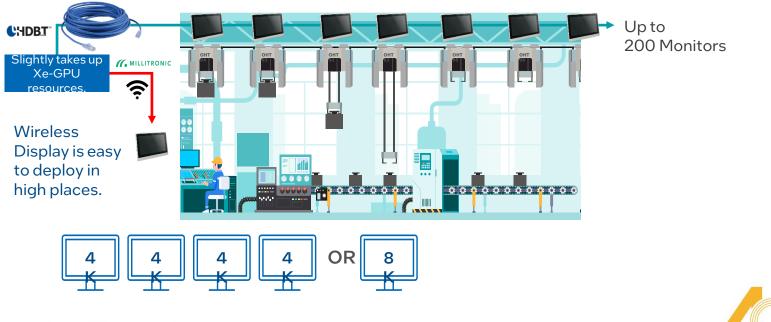
The key points you need to know to make SR-IOV practical, and how to give full play to the advantages of Intel's new generation hardware platform (such as Alder Lake).

POC Architecture Based On Alder Lake-S



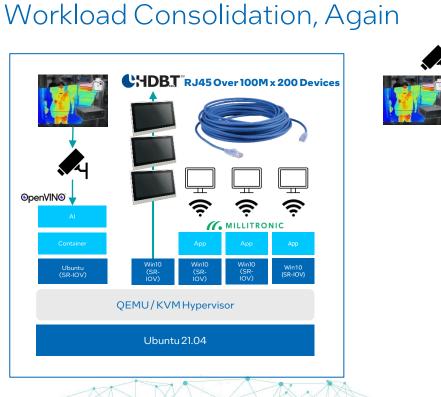
Refined For Industrial Automation Scenario

HDBaseT enables the use of a single category cable to meet all of industrial PC requirements, offering video & audio, Ethernet, controls, USB 2.0 and 100W power over 100m/328ft.



There are still four 4K screens or one 8K one for general monitoring purposes, especially for AI applications.

Applicable To Retailer Scenario





DFI ON INTEL GEN 12TH CORE PROCESSOR

When customers have needs, DFI's products is the worthiest of priority.

DFI's Products Are The Worthiest of Priority

EC543-ADS 12th Gen Intel Core Intel O670E Fanless . PCIe/PCI expansion slots . EC500-ADS EC510/511-ADS 12th Gen Intel Core 12th Gen Intel Core Intel 0670E/H610E Intel O670E 2HDMI/DP+1VGA.3M.2 PCIe / PCI expansion slots ST102-ADS WM343-ADS WM120-ADS 12th Gen Alder Lake Intel Core CPU . Intel Alder Lake-S, up to 16 Cores Intel Alder Lake-S, up to 8C/24T Intel R689E/0670E/H610E ECC support (On specific SKU) Intel O670E/H610E SO-DIMM DDR4 Intel R680E/0670E, 4x DDR4 SO-DIMM DDR4/DDR5(TBD) Personal I 1x16.3x4 12V/Wider voltage Power in Foot Stand, DC-in . FLEX ATX 250W/350W/400W/500W PCIe x16 slot FLEX ATX 250W ADS630-R680E/Q670E ADS310-R680E/Q670E ADP253 Intel Alder Lake-S, up to 16 Cores Intel Alder Lake-S, up to 16 Cores Intel Alder Lake-P, 6 core, 28W . ECC support (On specific SKU) ECC support (On specific SKU) Max 32/64GBDDR4 Intel R680E/O670E, 4x DDR4 Intel R680E/0670E 4x DDR4 9~36VVDC . 1x16, 4x4, 2 PCI 1x16.3 x4 1x 2.5GbE, 3x GbE LAN, 4x COM 2 M.2 M & 1 M.2 E kev 2 M.2 M & 1 M.2 E kev 6 USB 3.2 Gen2, up to 4 GbE LAN 6 USB 3.2 Gen2, up to 4 GbE LAN 8-Bit DIO 8-Bit DIO ADS101/103 ADP553 Fanless Intel Alder Lake-S, up to 8 core /24 threads Intel Alder Lake-P. 6 core Intel R689E/O670E/H610E 12~15W, 20~28W CPU option SO-DIMM DDR4/DDR5(TBD) . Max 32GB DDR4/DDR5(TBC) 12V/Wider voltage Power in 9~36VDC.fanless PCle x16 slot ADP171/173 ADP968

Intel Alder Lake-S

Planning

Fanless

Intel Alder Lake-P platform

Wide Voltage input 8.5V~20V

4-ch SO-DIMM DDR4

4 independent Display

Type 6, R3.1

. Intel Alder Lake-P platform

ADP9A2

- IBECC LPDDR4 onboard up to 16GB
- 4 independent Display
- Support SSD up to 1TB, dTPM Type 6, R3.1
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Last But Not The Least...



DFI EC70A-TGU Fanless Robust Embedded System Based on 11th Gen Intel® Core™ Processors Flexible I/O Configuration







ECI Ready

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Call To Action

• For Intel-related queries, please reach out to: Email: <u>insidesalesImapac@intel.com</u>

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